



N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BVsss	Rss(on) Typ	Is Max T _A = +25°C
12V	3.36 m Ω @ V _{GS} = 3.8 V	20A

Description

This new generation MOSFET is designed to minimize the on-state resistance (R_{SS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

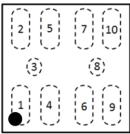
- Battery Management
- Load Switch
- Battery Protection

ESD PROTECTED



Bottom View

X2-TSN1820-10



Source 1: 1, 2, 4, 5 Gate1: 3 Source 2: 6, 7, 9, 10 Gate 2: 8

Top View

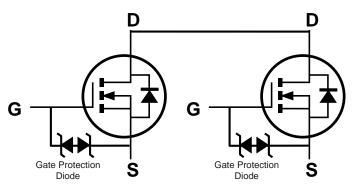
Features

- CSP with Footprint 1.84mm x 1.96mm
- Height = 0.30mm (Typical) for Low Profile
- · ESD Protection of Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

 https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: X2-TSN1820-10
- Terminal Connections: See Diagram Below
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiAu. Solderable per MIL-STD-202, Method 208 64
- Weight: 0.0026 grams (Approximate)



Equivalent Circuit

Ordering Information (Note 4)

Ī	Part Number	Case	Packaging
	DMN1001UCA10-7	X2-TSN1820-10	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



M7 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: G = 2019) M = Month (ex: 9 = September)

Date Code Key

Year	2019	2020	2	021	2022	202	3	2024	2025	20	26	2027
Code	G	Н		1	J	K		L	М	1	V	0
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Source-Source Voltage	Vsss	12	V		
Gate-Source Voltage	Vgss	±8	V		
0 (Steady State	T _A = +25°C		20	Δ.
Continuous Source Current (Note 5) Vgs = 4.5V		T _A = +70°C	ls ls	16	Α
0 1 0 0 1/11 5 1/1 0 5 1/1		14.5	^		
Continuous Source Current (Note 5) VGS = 2.5V	Is	11.5	А		
Pulsed Source Current (Note 6)	I _{SM}	90	Α		

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	P _D	1.0	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 7)	Reja	125	°C/W
Power Dissipation (Note 5)	PD	2.4	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 5)	$R_{ heta JA}$	52	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

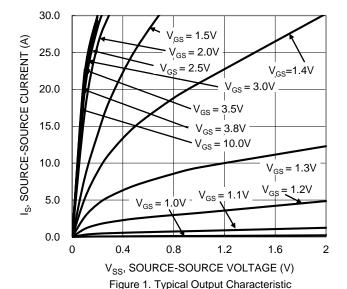
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

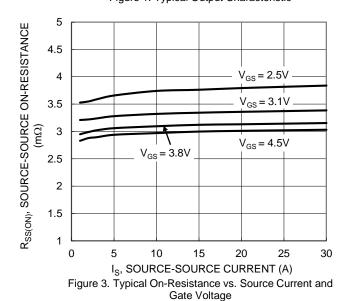
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Source -Source Breakdown Voltage	BVsss	12	1	-	V	$V_{GS} = 0V$, $I_{S} = 1mA$	
Zero Gate Voltage Drain Current TJ = +25°C	Isss	_	-	1	μΑ	Vss = 10V Vgs = 0V	
Gate-Source Leakage	Igss	_	_	±10	μΑ	$V_{GS} = \pm 8V$, $V_{SS}=0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	0.35	_	1.4	V	$V_{SS} = 10V$, $I_{S} = 0.87$ mA	
		1.9	3.19	3.55		$V_{GS} = 4.5V$, $I_{S} = 5A$	
Static Source-Source On-Resistance	Б	2.0	3.36	3.75	0	$V_{GS} = 3.8V$, $I_{S} = 5A$	
Static Source-Source On-Resistance	R _{SS(ON)}	2.25	3.69	4.8	mΩ	V _G S = 3.1V, I _S = 5A	
		2.5	4.38	6.9		V _G S = 2.5V, I _S = 5A	
Diode Forward Voltage	V _{SS}	_	0.7	1.2	V	$V_{GS} = 0V, I_S = 6.8A$	
DYNAMIC CHARACTERISTICS (Note 9)	DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss	_	2865	l			
Output Capacitance	Coss		500	l	pF	$V_{SS} = 6V, V_{GS} = 0V,$ f = 1.0kHz	
Reverse Transfer Capacitance	Crss	_	247	_		1 – 1.0KHZ	
Gate Resistance	Rg	_	375	_	Ω	$V_{GS} = 0V$, $V_{DS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	_	29	_			
Gate-Source Charge	Qgs	_	5.0	_	nC	$V_{DD} = 6V$, $V_{GS} = 4V$,	
Gate-Drain Charge	Q _{gd}	_	9.6	_	IIC	Is = 6.8A	
Gate Charge at V _{TH}	Q _{g(TH)}	_	5.2	_			
Turn-On Delay Time	t _{D(ON)}	_	508	_			
Turn-On Rise Time	t _R	_	1034	_	200	$V_{DD} = 6V$, $V_{GS} = 4V$,	
Turn-Off Delay Time	t _D (OFF)	_	1395	_	ns	$I_{S} = 6.8A$	
Turn-Off Fall Time	tF	_	2074	_			

Notes:

- 5. Device mounted on FR-4 material with 1inch² (6.45cm²), 2oz. (0.071mm thick) Cu.
- Device mounted on FR-4 material with Thich (6.45cm), 202. (0.07 min thick) Cu.
 Repetitive rating, pulse width limited by junction temperature.
 Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to production testing.







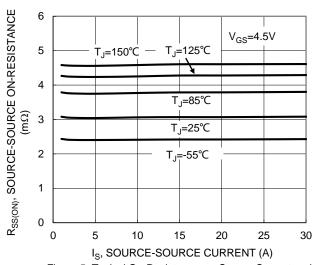
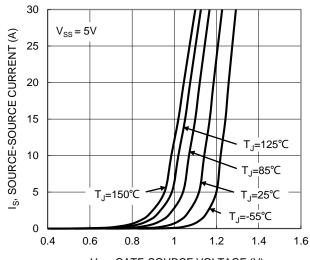


Figure 5. Typical On-Resistance vs. Source Current and Junction Temperature



V_{GS}, GATE-SOURCE VOLTAGE (V) Figure 2. Typical Transfer Characteristic

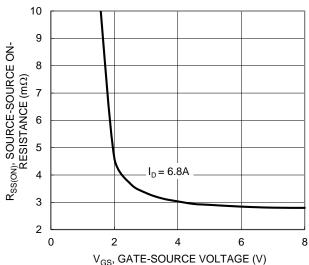


Figure 4. Typical Transfer Characteristic

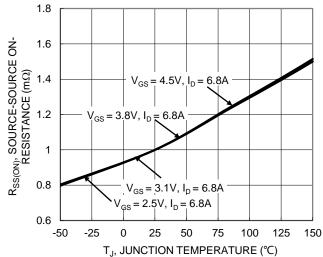


Figure 6. On-Resistance Variation with Junction
Temperature



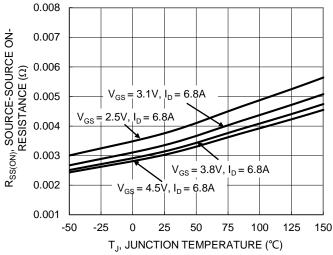
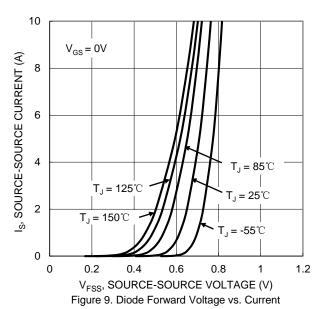


Figure 7. On-Resistance Variation with Junction Temperature



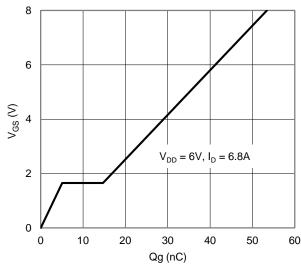


Figure 11. Gate Charge

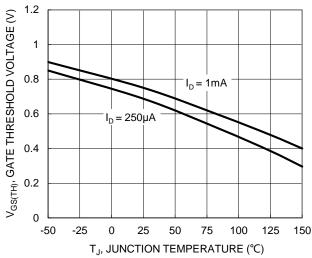
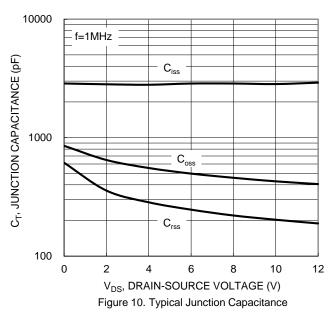


Figure 8. Gate Threshold Variation vs. Junction Temperature



1000 $R_{DS(ON)}$ Limited P_w =100µs 100 ID, DRAIN CURRENT (A) 10 $T_{J(Max)} = 150^{\circ}C T_C = 25^{\circ}C$ Single Pulse DUT on 1*MRP Board DC $V_{GS} = 4.5V$ 0.01 0.01 10 100 V_{DS}, DRAIN-SOURCE VOLTAGE (V)

Figure 12. SOA, Safe Operation Area



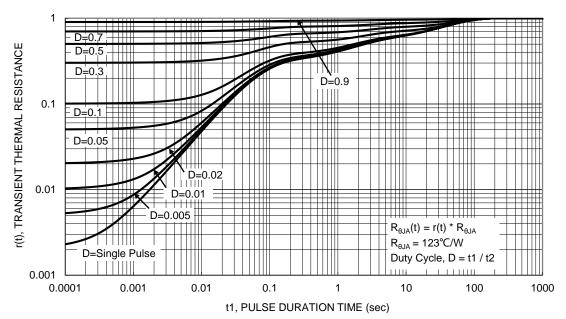


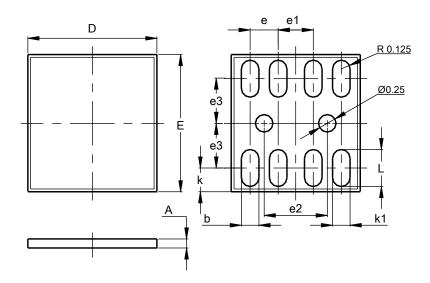
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-TSN1820-10

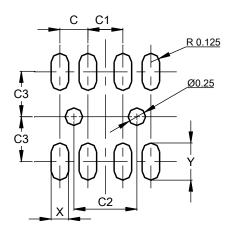


X2-TSN1820-10								
Dim	Min	Max	Тур					
Α	0.27	0.33	0.30					
b	0.22	0.28	0.25					
D	1.81	1.88	1.84					
Е	1.93	2.00	1.96					
e			0.40					
e1			0.50					
e2			0.90					
eЗ			0.64					
k			0.34					
k1			0.27					
L	0.50	0.56	0.53					
L1			1.81					
All Dimensions in mm								

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-TSN1820-10



Dimensions	Value (in mm)
С	0.40
C1	0.50
C2	0.90
C3	0.64
Х	0.25
Y	0.53



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